# **GP1S95**

#### Features

- 1. Compact package (3.6×3.4×4.7mm)
- 2. Gap width : 1.6mm
- 3. Slit width (detector side) : 0.3mm

#### Applications

- 1. DVD players
- 2. CD-ROM drivers
- 3. Floppy disk drivers

Absolute Maximum Ratings (Ta=25°C)								
	Parameter	Symbol	Rating	Unit				
Input	Forward current	IF	50	mA				
	Reverse voltage	VR	6	V				
	Power dissipation	Р	75	mW				
Output	Collector-emitter voltage	VCEO	Vceo 35					
	Emitter-collector voltage	VECO	6	V				
	Collector current	Ic	20	mA				
	Collector power dissipation	Pc	75	mW				
Total power dissipation		Ptot	100	mW				
Operating temperature		Topr	-25 to +85	°C				
	Storage temperature	Tstg	-40 to +100	°C				
*1 Soldering temperature		Tsol	260	°C				

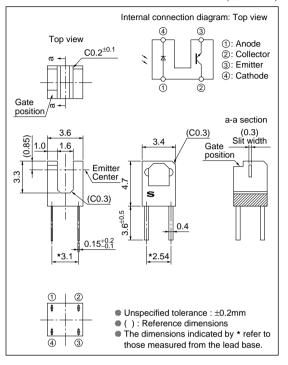
**n** ...

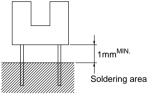
\*1 For 5s or less

# Subminiature, Transmissive Type Photointerrupter

#### Outline Dimensions

(Unit : mm)





Electro-optical Characteristics									
Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		VF	IF=20mA	-	1.2	1.4	V	
	Reverse current		Ir	V <sub>R</sub> =3V	-	-	10	μA	
Output	Collector dark current		Iceo	VCE=20V	-	-	100	nA	
Transfer charac- teristics	Collector current		Ic	Vce=5V, IF=5mA	50	-	300	μA	
	Response time	Rise time	tr	Vce=5V, Ic=100µA	-	35	100	μs	
		Fall time	tſ	$R_L=1\ 000\Omega$	-	35	100	μs	
	Collector-emitter saturation voltage		VCE(sat)	IF=10mA, Ic=50µA	-	-	0.4	V	

Fig.1 Forward Current vs. Ambient Temperature

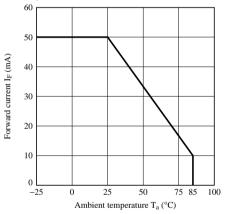


Fig.3 Forward Current vs. Forward Voltage

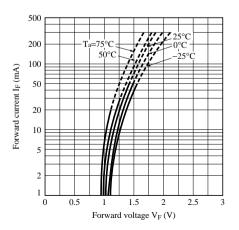


Fig.2 Power Dissipation vs. Ambient Temperature

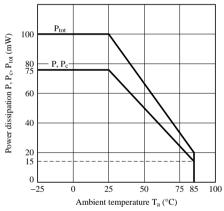
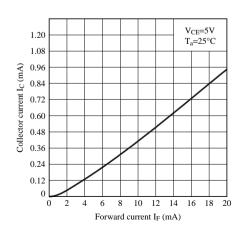


Fig.4 Collector Current vs. Forward Current



### Fig.5 Collector Current vs. Collector-emitter Voltage

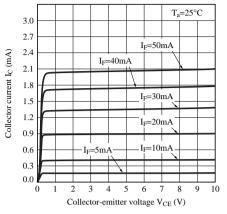


Fig.7 Collector - emitter Saturation Voltage vs. Ambient Temperature

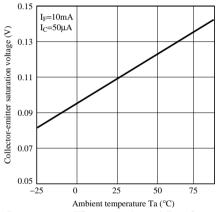
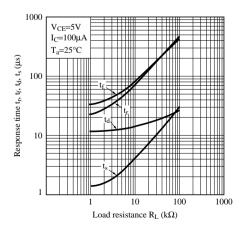


Fig.9 Response Time vs. Load Resistance



#### Fig.6 Relative Collector Current vs. Ambient Temperature

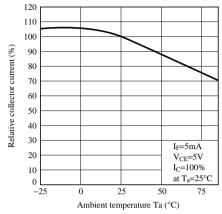


Fig.8 Collector Dark Current vs. Ambient Temperature

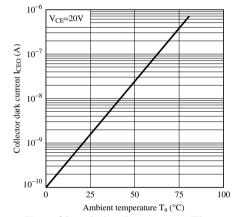


Fig.10 Test Circuit for Response Time

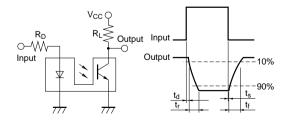
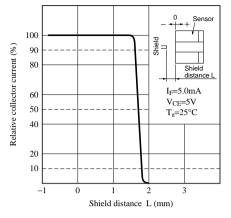
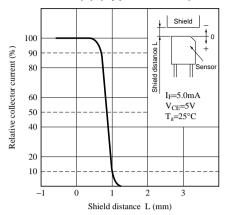


Fig.11 Relative Collector Current vs. Shield Distance (1) (Typical Value)



## Fig.12 Relative Collector Current vs. Shield Distance (2) (Typical Value)



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  - Office automation equipment
  - Telecommunication equipment [terminal]
  - Test and measurement equipment
  - Industrial control
  - Audio visual equipment
  - Consumer electronics

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